

151

PATENT NUMBER and ISSUE DATE

## U.S. UTILITY Patent Application

| APPL NUM  | FILING DATE                          | CLASS            | SUBCLASS | GAU   | EXAMINER           |  |  |  |  |  |
|---|--------------------------------------|------------------|----------|-------|--------------------|--|--|--|--|--|
| 10039199  | 01/04/2002                           | 257              | 79-      | 28114 | LOUIE              |  |  |  |  |  |
| **APPLICANT   | S: Chyi Jei                          | n-inn;           | WSL.     |       |                    |  |  |  |  |  |
|   |                                      |                  |          |       |                    |  |  |  |  |  |
| **CONTINUING DATA VERIFIED:   |                                      |                  |          |       |                    |  |  |  |  |  |
|   |                                      |                  |          |       |                    |  |  |  |  |  |
|   |                                      |                  |          |       |                    |  |  |  |  |  |
|   |                                      |                  |          |       |                    |  |  |  |  |  |
|   |                                      |                  |          |       |                    |  |  |  |  |  |
|   |                                      |                  |          |       |                    |  |  |  |  |  |
| 1   | PPLICATIONS VE                       |                  |          |       |                    |  |  |  |  |  |
| TAIWAN 9011   | 0239 04/27/2001                      | h                | 15L      |       |                    |  |  |  |  |  |
| PG-PUB DO N   | OT PUBLISH                           |                  | RESCI    | 1D 🖂  |                    |  |  |  |  |  |
| Foreign priority cla  |                                      | ¥i∕yes           |          |       | ATTORNEY DOCKET NO |  |  |  |  |  |
| 35 USC 119 condition<br>Verified and Acknowledge  | tions met<br>owledged Examiners's ir | ॼ॔ yes<br>ntials | ه ا ت ا  | V     | JLINP081           |  |  |  |  |  |
| TITLE: Buffer layer of light emitting semiconductor device and method of fabricating the same |                                      |                  |          |       |                    |  |  |  |  |  |
|   |                                      |                  | *        |       |                    |  |  |  |  |  |
|   | ·                                    |                  |          |       |                    |  |  |  |  |  |

| NOTICE OF ALLOWANCE MAILED |           |   | CLAIMS ALLOWED       |         |                        |            |  |  |  |
|----------------------------|-----------|---|----------------------|---------|------------------------|------------|--|--|--|
|                            |           | Assistant Examiner  | Total Claims         |         | Print Claim for<br>O.G |            |  |  |  |
| ISSUE FEE                  |           |   | DRAWING              |         |                        |            |  |  |  |
| Amount Due                 | Date Paid |   | Sheets Drwg.         | Figs.Dn | vg.                    | Print Fig. |  |  |  |
| <u></u>                    |           | Primary Examiner  |                      |         | <u> </u>               |            |  |  |  |
| TERMINAL                   |           | PREPARED FOR ISSUE  | Application Examiner |         |                        |            |  |  |  |
|                            | DISCLAMER | WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only. |                      |         |                        |            |  |  |  |
|                            |           | FILED WITH: DISK  | (CRF)                | - [     |                        | CD-ROM     |  |  |  |

(Attached in pocket on right inside flap)